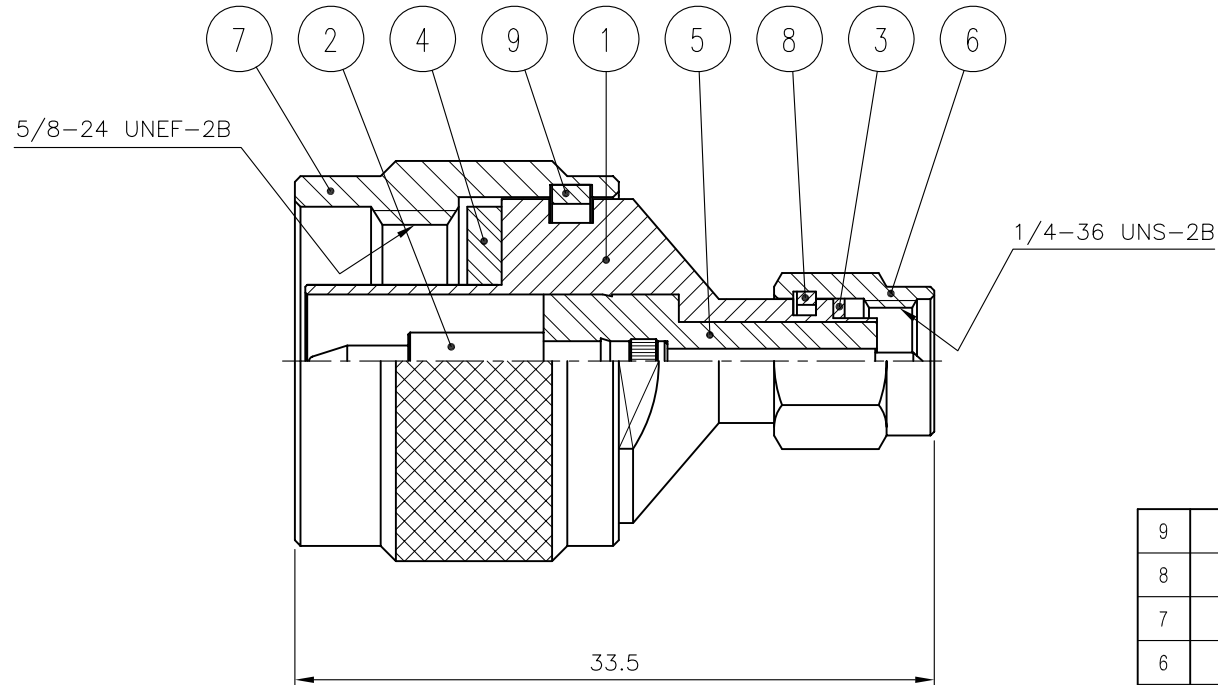


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration			2004.08.05.
1	(설변처리 No. 201001-0013) (조립치수 부적합으로 인한 PIN, TEFLON 변경)	D.W.KANG	Y.H.CHOI	2010.01.18.
2	(설변처리 No. 201309-0004) (BODY 낙시바를 추가, PIN 불량 추가)	M.H.SONG	I.C.KIM	2013.09.06.



9	SPRING RING	1	PBR	Nickel Plate	DSR00020-5/1
8	SPRING RING	1	SUS	부동태 처리	DSR00002-5/1
7	CAP	1	MBsBD	Nickel Plate	DCU00059-5/1
6	CAP	1	MBsBD	Gold Plate	DCU00005-5/1
5	INSULATOR	1	TEFLON		DAI00134-N/1 DAI00112-N/1
4	GASKET	1	SILICONE RUB		DGK00013-N/1
3	GASKET	1	SILICONE RUB		DGK00004-N/1
2	CONTACT	1	MBsBD	Gold Plate	DAC00200-5/3 DAC00200-5/2
1	BODY	1	MBsBD	Nickel Plate	DAD00205-5/2 DAD00205-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

* ELECTRICAL SPECIFICATIONS
 Impedance : 50Ω
 Frequency Range : DC~6GHz
 V.S.W.R (Max) : 1.2

TOLERANCE	Decimal	DATE 2013. 09. 06.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I. C. KIM	
MATERIAL	-	CHECKED BY	E. H. KIM	TITLE N (P) - SMA (P) ADAPTOR
		DRAWN BY	M.H.SONG	
FINISH	-	SCALE	UNIT	DWG NO. AD00332-7/2 REVISION 2 SHEET 1 of 1
		2.5/1	mm	